



REQUEST FOR QUOTATION

WAFER EDGE FILM REMOVAL PROCESS LAB

FILL IN THIS FORM AND EMAIL TO [david@uvtechsystems.com](mailto:david@uvtechsystems.com) or fax 1-978-440-7099

NAME: \_\_\_\_\_

TITLE: \_\_\_\_\_

E-MAIL: \_\_\_\_\_ PHONE: \_\_\_\_\_

COMPANY: \_\_\_\_\_

FAB NAME &  
LOCATION: \_\_\_\_\_

PRODUCT TYPE & WAFER SIZE: \_\_\_\_\_

1. FILM STACK: (Indicate actual stack to be removed, including all layers; optical n & k @~355nm is useful if available)

Layer	Material	Deposition Method	Thickness (nm)	n	k	Stop Layer?
Top						
2nd						
3rd						
4th						
Substrate						

2. NEXT TWO PROCESS STEPS:

NOTES:

- A minimum of four wafers with the complete film stack to be used for BKM process development. These wafers will be cut into coupons for analytical purposes. Additional wafers will be required for whole wafer results.
- UV Tech will provide a detailed written report and analytical data provided by Nanolab with recommended BKM
- Price quotation will include UVTech services and an estimate of analytical lab costs.
- Please specify analytical requirements: EDS, profilometry, SEM, SIMS, and others available.